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General Description:

Module shall be an encapsulated assembly, weight shall not exceed 3 ounces, resistors, carbon shall be selected per mil-r-39008, resistors, metal film shall be per mil-r-10509, resistors, wirewound shall be per mil-r-93, diodes and transistors shall be per mil-s-19500, microelectronic circuits shall be selected from device families previously used in military applications, pin material shall be brass per qq-b-626, composition 22, pin plating shall be electro-solder per mil-f-14072, m222 or equivalent, environmental conditions after encapsulation: shock per mil-std-202, method 213, condition j, vibration per mil-std-202, method 201, 2.170 in. O/a lg, 1.535 in. O/a w, 1.240 in. O/a h

Shelf Life:

N/a

Unit Of Measure:

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Demilitarization:

Yes - demil/mli